

# Product Carbon Footprint Report

TUF GAMING B760M-PLUS WIFI D4

Report produced June, 2025

## Product Introduction

1.0 kg

Product weight

N/A

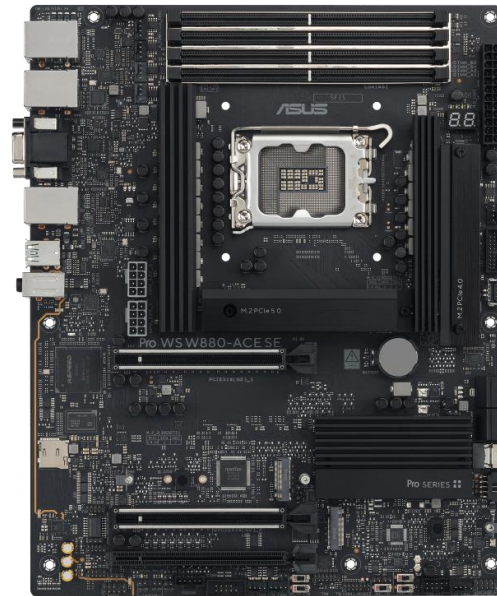
Screen Size

Worldwide

Use location

China

Final Manufacturing location



## WHY WE DO

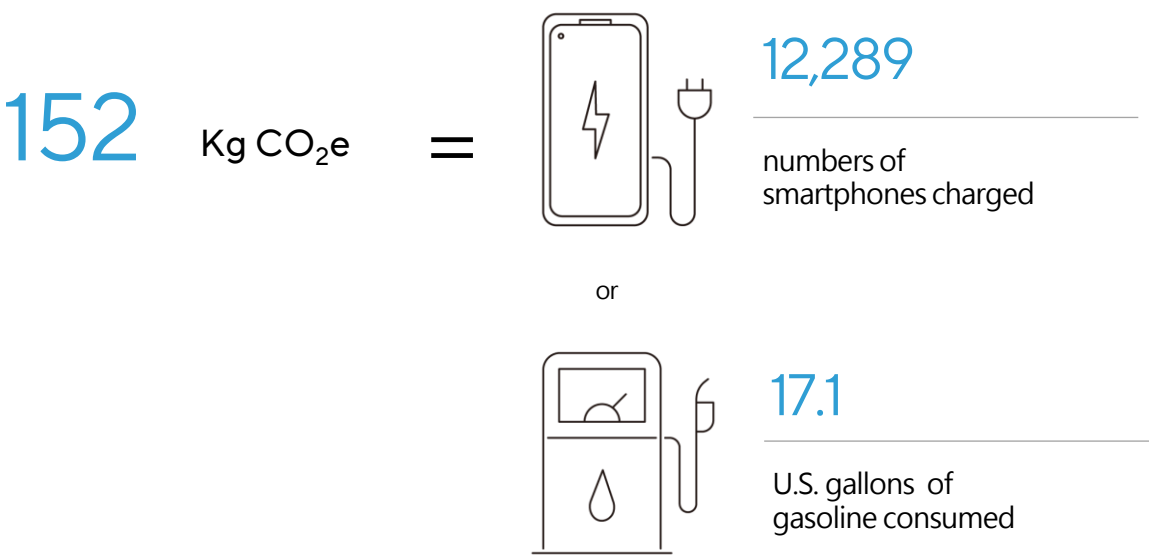
ASUS is committed to continuously improving the environmental performance of the products you purchase. Through product carbon footprint reports (PCF), we show the environmental impact of product lifecycles from design to disposal.

## HOW WE CONDUCT

Life cycle assessment (LCA) is commonly referred to as a "cradle-to-grave" analysis. Throughout the entire life cycle of a product, and the assessment includes the contributions material extraction, manufacturing, packaging and ship, use and end-of-life management.

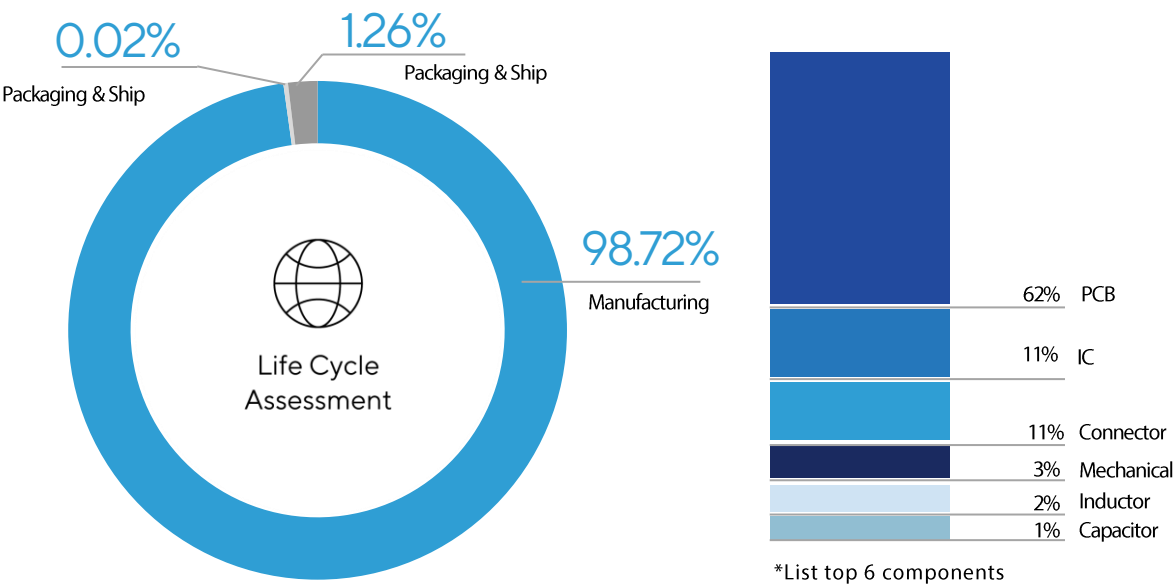
# WHAT WE PRESENT

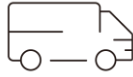
This product’s estimated carbon footprint:  
We will demonstrate the total product carbon emission and also provide the approximate equivalencies to let user well understand the concept of carbon emission.



The methodology of calculations are based on [US EPA](#)

The estimated impact across the product's life cycle and with the information of main factors from manufacturing phase.



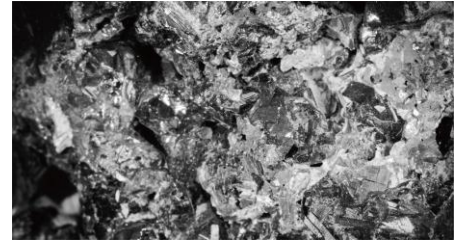


Phase 1 Manufacturing 2 Packaging & Ship 3 End-of-Life Management

## Phase 1 Manufacturing

### Raw Material Procurement

ASUS controls all materials used in the manufacture of products, including the purchase of metals. To ensure that metals meet legal mining and operations, ASUS requires suppliers that meet third party verification. The source of raw materials is in line with the supply chain of the international Responsible Mineral Initiative (RMI) due diligence and management.



### Hazardous Substance Free

All ASUS products comply with the mandatory requirement from European Union's Electrical and Electronic Equipment Restriction of Hazardous substances (EU RoHS) and other national hazardous substances control laws and other national hazardous substances control laws, and all print circuit board laminates also meet voluntary halogen-free requirement.



### Human Right

ASUS protects labor rights and implements responsibility manufacturing. To commit the protection, ASUS joined to Responsible Business Alliance as the full member.



### Supplier Energy Use

Final assembly site are transitioning to renewable energy progressively for ASUS production

## Phase 2 Packaging and Ship

ASUS have designed the packaging to minimize its weight and volume, which helps conserve natural resources and allows more devices to be transported in a single shipping container. TUF GAMING B760M-PLUS WIFI D4 use 80% recycled content by total weight of wood based fiber.





Product modular design, 90% materials and components are easy to recycle and reuse. ASUS promises to recycle second-hand electronic products, and cooperate with qualified recyclers to properly recycle the waste products, in line with the EU Waste Electrical and Electronic Equipment Directive (EU WEEE) and other national waste management laws. The five major regions provide recycling services, including Europe, North America, Taiwan, China, and Australia.

## DEFINITIONS

### Methodology

Estimated emissions are calculated in accordance with guidelines and requirements as specified by ISO 14040, ISO 14044 and follow ISO 14067 to conduct product carbon footprint for quantification. There is inherent uncertainty in modeling carbon emissions due primarily to data limitations.

### Life Cycle

With reference to the ISO 14040 standard, the main stages of the environmental life cycle of the product are defined raw material procurement, product manufacturing, product transportation, product use, and product waste.

### Calculation

The environmental footprint of this product is calculated using the life cycle assessment software SimaPro 9.4; and based on the Ecoinvent 3.9 database data, the carbon footprint of each phase is calculated using the IPCC 2021 GWP 100 method.

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### Manufacturing

It includes the refining, manufacturing, transportation of raw materials, as well as the manufacture, assembly and transportation of parts and packaging materials.

### Packaging and Ship

The route is from the final assembly factory to the Shanghai Airport in China, and then distributed to the warehouses in various continents. Transportation methods include: land by truck and rail, and air by airplane. Considering the reduction of transportation carbon footprint, ASUS prioritizes the use of rail in land.

### End-of-Life Management

According to the recovery processing vendor model and path calculation of ASUS regional cooperation.

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### Uncertainty

There are uncertainties in this report caused of the following factors:

① Uncertainty in modeling carbon emissions due primarily to data limitations. For the top component contributors to Asus's carbon emissions, Asus addresses this uncertainty by developing detailed process-based environmental models with Asus-specific parameters. For the remaining elements of Asus's carbon footprint, rely on industry average data and assumptions. Calculation includes emissions for the following life cycle phases contributing to Global Warming Potential (GWP 100 years) in CO<sub>2</sub> equivalency factors (CO<sub>2</sub>e).

② Impact calculation of production phase including the refining, manufacturing, transportation of raw materials, as well as the manufacture, assembly and transportation of parts and packaging materials are based on the database of SimaPro software, not primary data.



### Modular design:

90% materials and parts are easy to recycle and reuse in waste treatment plants



To see more  
ASUS' sustainability effort